

LOCTITE ABLESTIK ABP 2038

November 2015

PRODUCT DESCRIPTION

LOCTITE ABLESTIK ABP 2038 provides the following product characteristics:

Technology	Proprietary Hybrid Chemistry
Appearance	Red paste
Cure	Heat cure
Product Benefits	• Non-conductive • Low warpage • One component • Fast cure • Low temperature cure • Low stress
Application	Die attach
Typical Package Application	CCM
Filler Type	Silica
Key Substrates	Most metals and Plastics

LOCTITE ABLESTIK ABP 2038 non-conductive die attach adhesive has been formulated for use in high throughput die attach applications. This material is designed to minimize stress and resulting warpage between dissimilar surfaces.

TYPICAL PROPERTIES OF UNCURED MATERIAL

Thixotropic Index (0.5/5 rpm)	3.5
Viscosity, Brookfield CP51, 25 °C, mPa·s (cP):	
Speed 5 rpm	14,000
Shelf Life @ -40°C (from date of manufacture), days	365
Work Life @ 25°C, 25% change in viscosity, hours	24
Flash Point - See SDS	

TYPICAL CURING PERFORMANCE

Cure Schedule

2 minutes @ 120°C

Alternate Cure Schedule

30 minutes @ 150°C or

60 minutes @ 80°C

The above cure profiles are guideline recommendations. Cure conditions (time and temperature) may vary based on customers' experience and their application requirements, as well as customer curing equipment, oven loading and actual oven temperatures.

TYPICAL PROPERTIES OF CURED MATERIAL

Physical Properties

Coefficient of Thermal Expansion, TMA expansion mode:	
Below Tg, ppm/°C	50
Above Tg, ppm/°C	168
Glass Transition Temperature, TMA expansion, °C	-36

Extractable Ionic Content, :

Chloride (Cl-)	<10
Sodium (Na+)	<10
Potassium (K+)	<10

DMA Modulus:

@ 25°C	N/mm ²	720
	(psi)	(104,430)
@ 100°C	N/mm ²	80
	(psi)	(11,600)
@ 250°C	N/mm ²	75
	(psi)	(10,880)

TYPICAL PERFORMANCE OF CURED MATERIAL

Sample cured 2 minutes @ 120°C.

Miscellaneous

Die Shear Strength :

3 x 3 mm Si die on BGA, kg-f	20
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Chip Warpage :

5 x 5 mm Si die on 0.38 µm thick BGA µm	1.5
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GENERAL INFORMATION

For safe handling information on this product, consult the Material Safety Data Sheet, (MSDS).

THAWING:

1. Allow container to reach room temperature before use.
2. After removing from the freezer, set the syringes to stand vertically while thawing.
3. DO NOT open the container before contents reach 25°C temperature. Any moisture that collects on the thawed container should be removed prior to opening the container.
4. DO NOT re-freeze. Once thawed to 25°C, the adhesive should not be re-frozen.

DIRECTIONS FOR USE

1. Thawed adhesive should immediately be placed on dispense equipment for use.
2. If the adhesive is transferred to a final dispensing reservoir, care must be exercised to avoid entrapment of contaminants and/or air into the adhesive.
3. Adhesive must be completely used within the product's recommended work life.
4. Silver-resin separation may occur if the adhesive is left out at 25 °C beyond the recommended work life.
5. Apply enough adhesive to achieve a 25 to 50 µm wet bondline thickness, dispensed with approximately 25 to 50 % filletting on all sides of the die.
6. Alternate dispense amounts may be used depending on the application requirements.
7. Star or crossed shaped dispense patterns will yield fewer bondline voids than the matrix style of dispense pattern.

Not for product specifications

The technical data contained herein are intended as reference only. Please contact your local quality department for assistance and recommendations on specifications for this product.

Storage

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

Optimal Storage: -40 °C. Storage below minus (-)40 °C or greater than minus (-)40 °C can adversely affect product properties.

Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.

Conversions

$(^{\circ}\text{C} \times 1.8) + 32 = ^{\circ}\text{F}$

$\text{kV/mm} \times 25.4 = \text{V/mil}$

$\text{mm} / 25.4 = \text{inches}$

$\text{N} \times 0.225 = \text{lb}$

$\text{N/mm} \times 5.71 = \text{lb/in}$

$\text{psi} \times 145 = \text{N/mm}^2$

$\text{MPa} = \text{N/mm}^2$

$\text{N} \cdot \text{m} \times 8.851 = \text{lb} \cdot \text{in}$

$\text{N} \cdot \text{m} \times 0.738 = \text{lb} \cdot \text{ft}$

$\text{N} \cdot \text{mm} \times 0.142 = \text{oz} \cdot \text{in}$

$\text{mPa} \cdot \text{s} = \text{cP}$

Disclaimer**Note:**

The information provided in this Technical Data Sheet (TDS) including the recommendations for use and application of the product are based on our knowledge and experience of the product as at the date of this TDS. The product can have a variety of different applications as well as differing application and working conditions in your environment that are beyond our control. Henkel is, therefore, not liable for the suitability of our product for the production processes and conditions in respect of which you use them, as well as the intended applications and results. We strongly recommend that you carry out your own prior trials to confirm such suitability of our product.

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Reference 0.1